

Lau

## Chip on Board

Technology for Multichip Modules

---

This book is a one-stop guide to the state of the art of COB technology. For professionals active in COB and MCM research and development, those who wish to master COB and MCM problem-solving methods, and those who must choose a cost-effective design and high-yield manufacturing process for their interconnect systems, here is a timely summary of progress in all aspects of this fascinating field. It meets the reference needs of design, material, process, equipment, manufacturing, quality, reliability, packaging, and system engineers, and technical managers working in electronic packaging and interconnection.



**fachmedien.de**  
WISSEN. EINFACH. FINDEN.

**213,99 €**

199,99 € (zzgl. MwSt.)

*Lieferfrist: bis zu 10 Tage*

---

**Artikelnummer:** 9780442014414

**Medium:** Buch

**ISBN:** 978-0-442-01441-4

**Verlag:** Springer Nature Singapore

**Erscheinungstermin:** 30.06.1994

**Sprache(n):** Englisch

**Auflage:** 1994. Auflage 1994

**Produktform:** Gebunden

**Gewicht:** 2170 g

**Seiten:** 556

**Format (B x H):** 152 x 238 mm



**fachmedien.de**  
WISSEN. EINFACH. FINDEN.

**Kundenservice Fachmedien Otto Schmidt**

Neumannstraße 10, 40235 Düsseldorf | [kundenservice@fachmedien.de](mailto:kundenservice@fachmedien.de) | 0800 000-1637 (Inland)

01.08.2024 | 03:21 Uhr

